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Fairchild Semiconductor
FCH47N60F_F133

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FAIRCHILD SEMICONDUCTOR®

October 2013

FCH47N60F

N-Channel SuperFET® FRFET® MOSFET

600 V, 47 A, 73 mΩ

Features

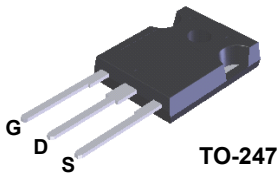
- 650 V @ T_J = 150 °C
- Typ. $R_{DS(on)}$ = 58 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 210 nC)
- Low Effective Output Capacitance (Typ. C_{oss}eff. = 420 pF)
- 100% Avalanche Tested
- RoHS Compliant

Applications

- Solar Inverter
- AC-DC Power Supply

Description

SuperFET® MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance.This technology is tailored to minimize conduction loss, provide superior switching performance,dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server / telecom power, FPD TV power, ATX power and industrial power applications. SuperFET FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



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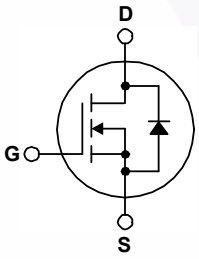


Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	FCH47N60F_F133	Unit
V_{DSS}	Drain-Source Voltage	600	V
I_D	Drain Current - Continuous (T_C = 25°C) - Continuous (T_C = 100°C)	47 29.7	A A
I_{DM}	Drain Current - Pulsed (Note 1)	141	A
V_{GSS}	Gate-Source voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy (Note 2)	1800	mJ
I_{AR}	Avalanche Current (Note 1)	47	A
E_{AR}	Repetitive Avalanche Energy (Note 1)	41.7	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	50	V/ns
P_D	Power Dissipation (T_C = 25°C) - Derate above 25°C	417 3.33	W W/°C
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T_L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300	°C

Thermal Characteristics

Symbol	Parameter	FCH47N60F_F133	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	41.7	°C/W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FCH47N60F	FCH47N60F_F133	TO-247	-	-	30

Electrical Characteristics

T_C = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0V, I_D = 250μA, T_J = 25°C	600	--	--	V
		V_{GS} = 0V, I_D = 250μA, T_J = 150°C	--	650	--	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250μA, Referenced to 25°C	--	0.6	--	V/°C
BV_{DS}	Drain-Source Avalanche Breakdown Voltage	V_{GS} = 0V, I_D = 47A	--	700	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 600V, V_{GS} = 0V V_{DS} = 480V, T_C = 125°C	-- --	-- --	10 100	μA μA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30V, V_{DS} = 0V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30V, V_{DS} = 0V	--	--	-100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250μA	3.0	--	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10V, I_D = 23.5A	--	0.062	0.073	Ω
g_{FS}	Forward Transconductance	V_{DS} = 40V, I_D = 23.5A	--	40	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz	--	5900	8000	pF
C_{oss}	Output Capacitance		--	3200	4200	pF
C_{rss}	Reverse Transfer Capacitance		--	250	--	pF
C_{oss}	Output Capacitance	V_{DS} = 480V, V_{GS} = 0V, f = 1.0MHz	--	160	--	pF
C_{oss} eff.	Effective Output Capacitance	V_{DS} = 0V to 400V, V_{GS} = 0V	--	420	--	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 300V, I_D = 47A R_G = 25Ω	--	185	430	ns
t_r	Turn-On Rise Time		--	210	450	ns
$t_{d(off)}$	Turn-Off Delay Time		--	520	1100	ns
t_f	Turn-Off Fall Time	(Note 4)	--	75	160	ns
Q_g	Total Gate Charge	V_{DS} = 480V, I_D = 47A V_{GS} = 10V	--	210	270	nC
Q_{gs}	Gate-Source Charge		--	38	--	nC
Q_{gd}	Gate-Drain Charge	(Note 4)	--	110	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	47	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	141	A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0V, I_S = 47A	--	--	1.4	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0V, I_S = 47A dI_F/dt =100A/μs	--	240	--	ns
Q_{rr}	Reverse Recovery Charge		--	2.04	--	μC

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_{AS} = 18A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. I_{SD} ≤ 47A, di/dt ≤ 1200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

Typical Performance Characteristics

Figure 1. On-Region Characteristics

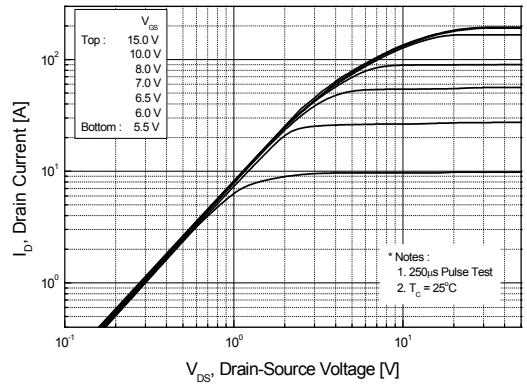


Figure 2. Transfer Characteristics

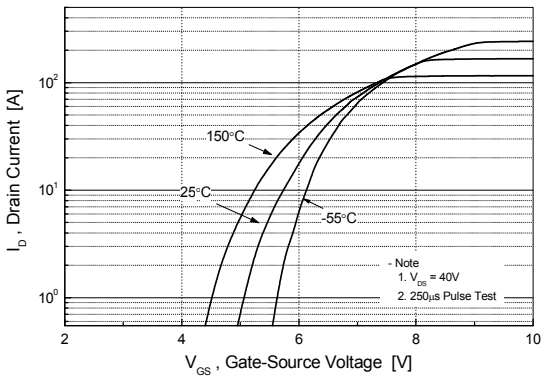


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

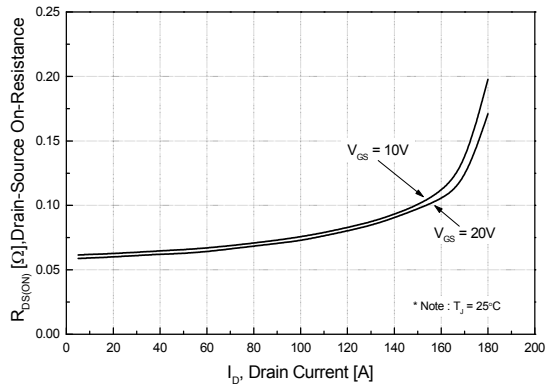


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

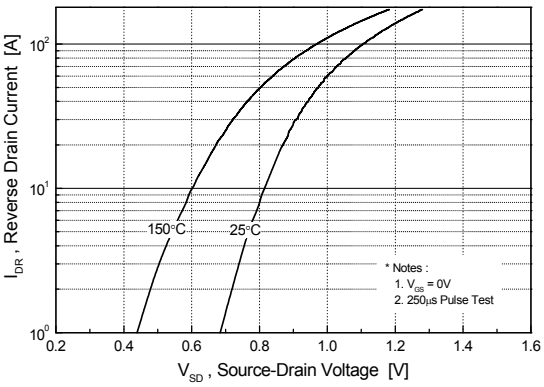


Figure 5. Capacitance Characteristics

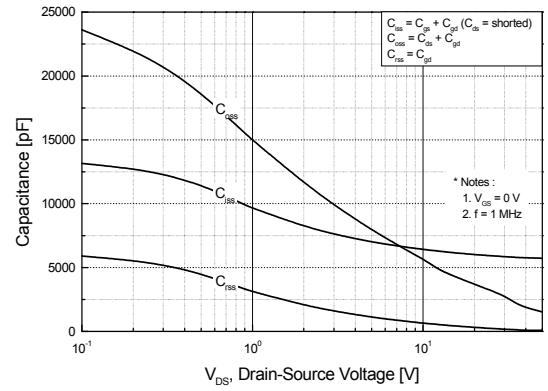
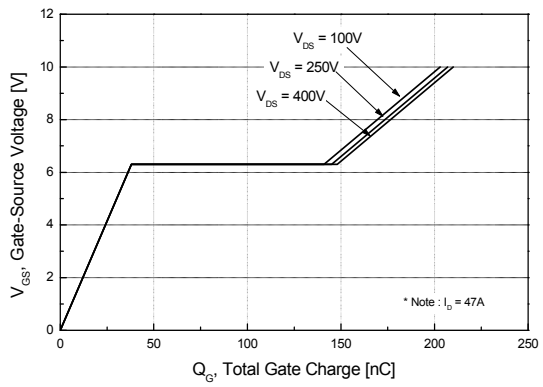


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

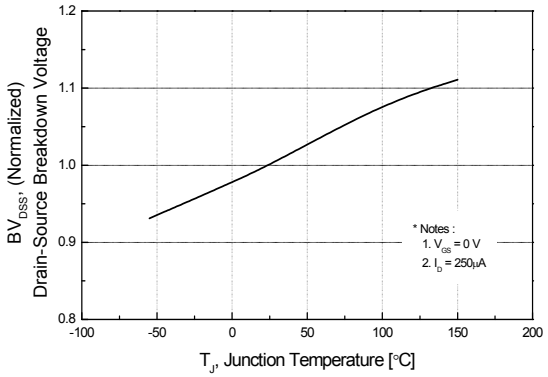


Figure 8. On-Resistance Variation vs. Temperature

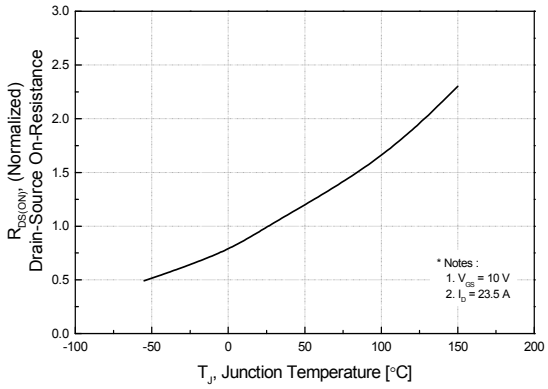


Figure 9. Safe Operating Area

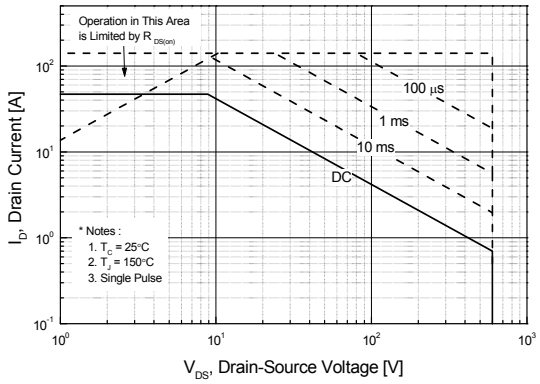


Figure 10. Maximum Drain Current vs. Case Temperature

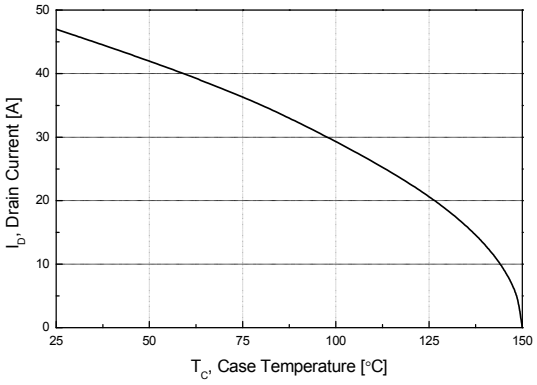


Figure 11. Transient Thermal Response Curve

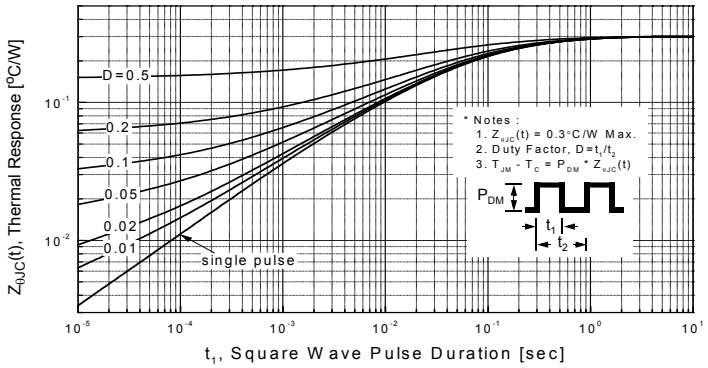


Figure 12. Gate Charge Test Circuit & Waveform

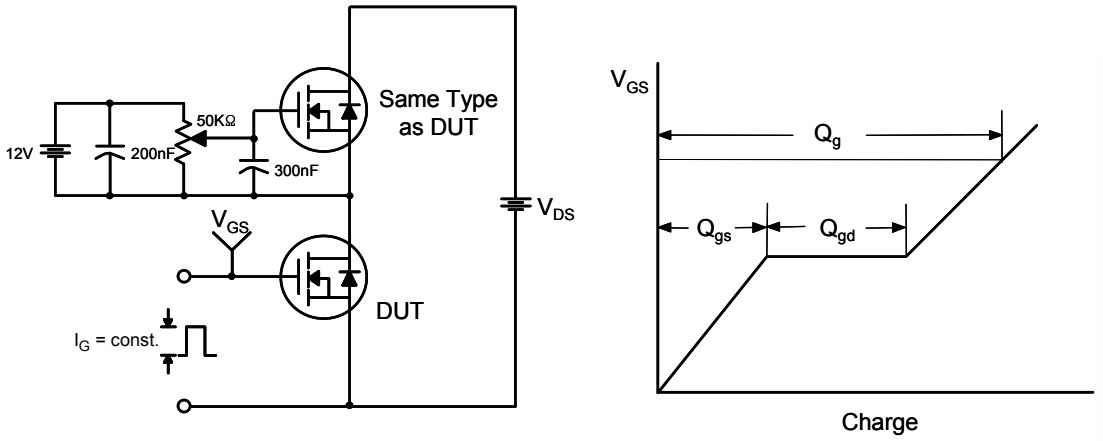


Figure 13. Resistive Switching Test Circuit & Waveforms

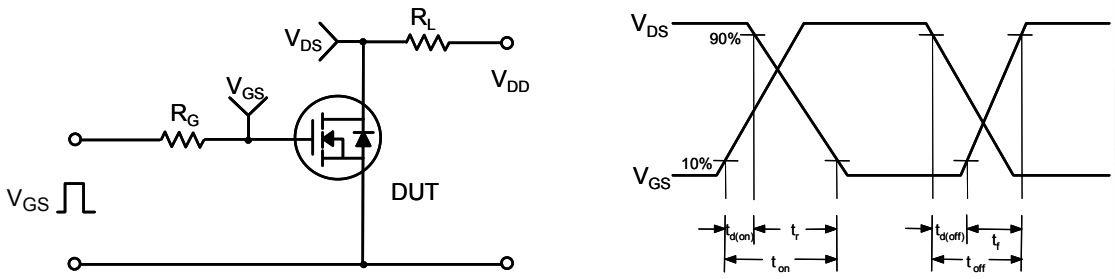


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

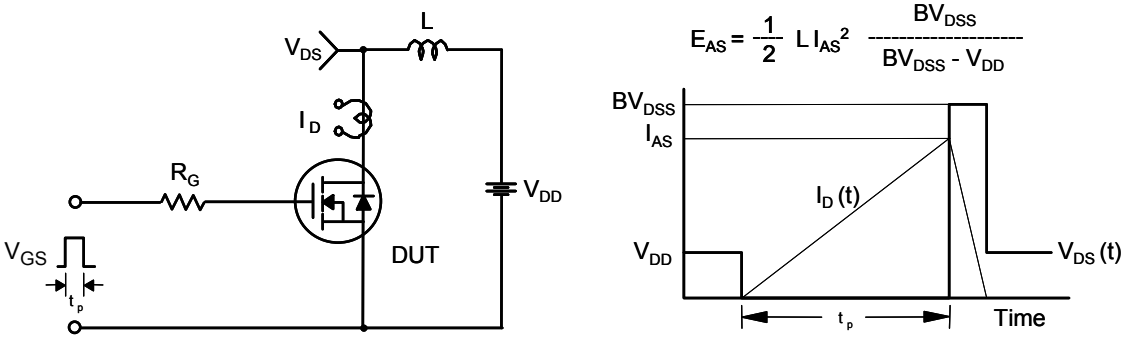
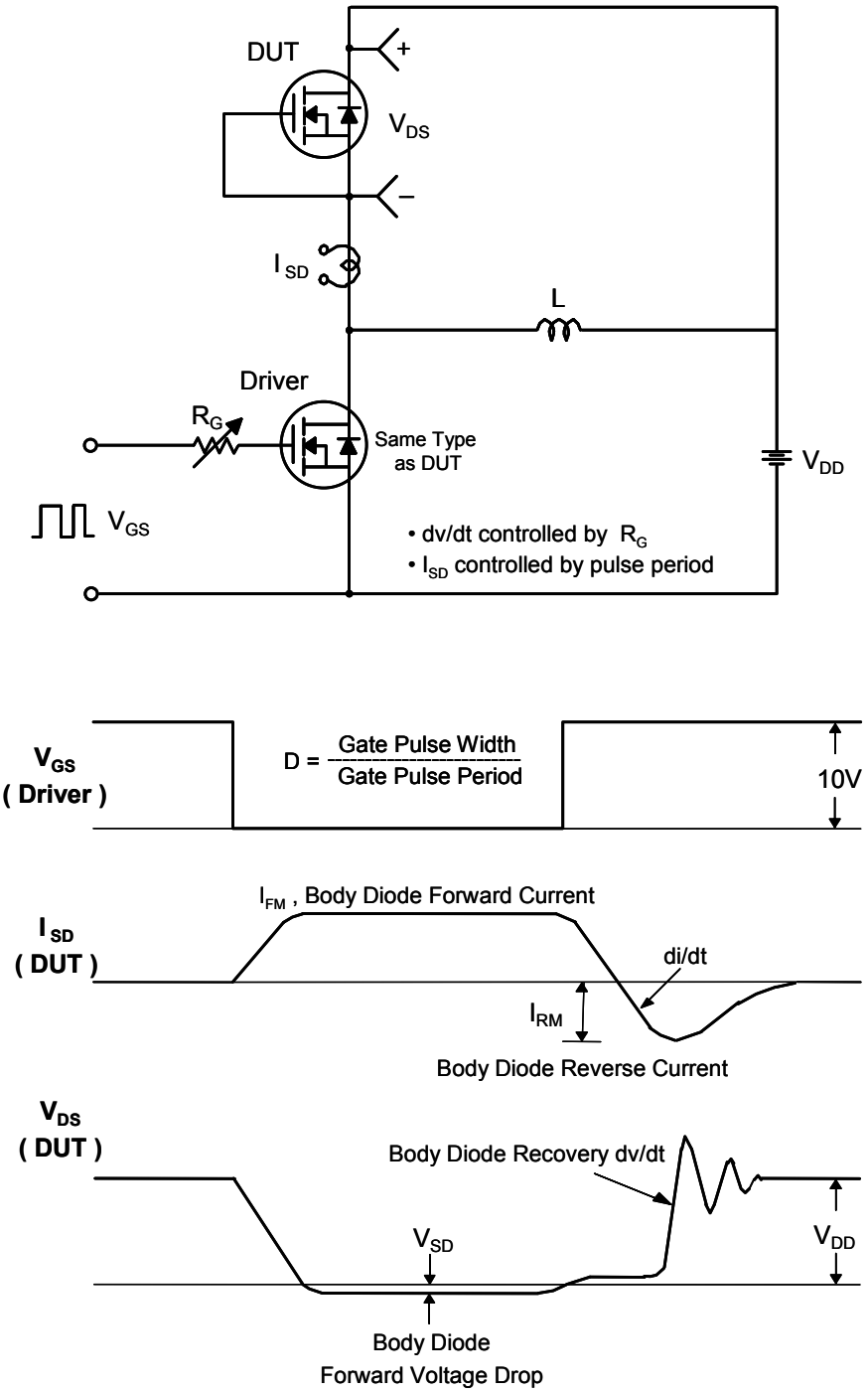


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



Mechanical Dimensions

TO-247 3L

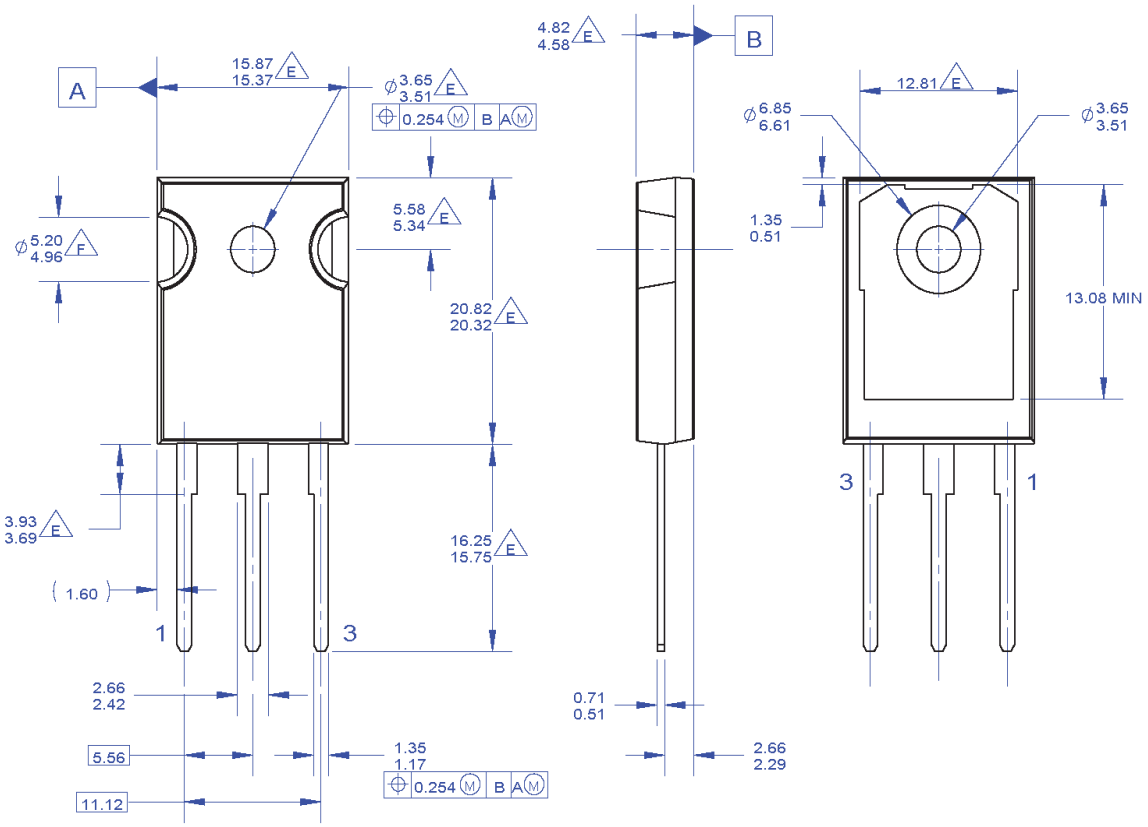


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Figure 16. TO-247,Molded, 3 Lead, Jedec Variation AB

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Dimension in Millimeters

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